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## **SEMI MEMS & Imaging Sensors Summit – August 23, 2023**

SEMI MEMS & Imaging Sensors Summit

**More than 40 experts will gather on the 19<sup>th</sup> – 21<sup>st</sup> September at the SEMI MEMS & Imaging Sensors Summit to share insights into new innovation opportunities for MEMS, imaging and sensors applications and their potential to enable a smarter and more sustainable world.**

Registration is open for the exhibition and conferences at the World Trade Center (WTC) in Grenoble, France.

Themed Ubiquitous Sensing for A Sustainable World, the summit will explore the latest MEMS, imaging and sensors technologies, developments and trends. The event is hosted by SEMI Europe and the MEMS & Sensors Industry Group (MSIG), a SEMI Technology Community.

“Rapid progress in the development and manufacture of MEMS and image sensors products featuring AI and machine learning is leading a new wave of innovative applications,” said Laith Altimime, president of SEMI Europe. “We look forward to hosting industry thought leaders as they share their visions for how new advances promise to drive more eco-friendly products and applications.”

### **Featured speakers at MEMS & Imaging Sensors Summit**

Thought leaders will discuss MEMS and imaging sensors manufacturing advances and how the latest innovations are powering intelligent applications across sectors such as communications, mobility, IoT, entertainment and medical.

- Hod Finkelstein, Head of Cameras and Depth, Reality Labs, Meta
- Bernard Kress, Director, Optical Engineering, Augmented Reality Hardware, Google
- Lia Li, ZPM Co-founder and CEO of Zero Point Motion
- Kilian Bilger, Vice President Engineering of Sensor Components, Bosch
- Theodor Nielsen, CEO of NIL Technology (NILT)
- Isabella Drolz, Vice President of Product Marketing Comet Yxlon
- Moti Margalit, CEO of SonicEdge
- Martin Croome, Vice President of Marketing GreenWaves Technologies
- Julia Brueckner, Global Applications & Product Engineering Manager for Packaging & Wafer Business Unit, Corning Incorporated

### **Gala Dinner and networking opportunities**

The SEMI MEMS & Imaging Sensors Summit will feature networking opportunities including a complimentary welcome reception on September 19 in the exhibition area at the WTC and a gala dinner on 20<sup>th</sup> September. Registration for the gala dinner at the Chateau de Sassenage is open.

## **Exhibitors at MEMS & Imaging Sensors Summit**

- Adeia
- AEMtec
- Besi
- Comet Yxlon
- Eurofins | MASER
- EV Group (EVG)
- FormFactor
- OPTIM Wafer Services
- Philips MEMS & Micro Devices
- Polytechnik AS
- ProSys
- Pyxalis
- SET Corporation
- Siconnex
- Siemens EDA (represented by EDA Solutions Limited)
- Sumitomo Precision Products
- SUSS Microtec
- W. L. Gore & Associates

## **Premier sponsors**

- Platinum Sponsors: Adeia, ASE, Infineon, KLA and Siconnex
- Gold Sponsors: Comet Yxlon and SUSS MicroTec
- Event sponsors: Beneq, Evatec, EV Group (EVG), Okmetic and Teledyne MEMS

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